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(12) **United States Design Patent** (10) **Patent No.:** **US D953,301 S**
Ye (45) **Date of Patent:** **** May 31, 2022**

(54) **WIRELESS HEADSET**
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CPC H04R 1/10; H04R 25/00; H04R 25/02; H04R 1/1066; H04R 1/1016; H04R 5/033; H04R 5/0335; H04R 1/1083; H04R 1/1041; H04R 1/1075; H04R 1/1058; H04R 1/1091
See application file for complete search history.

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(57) **CLAIM**

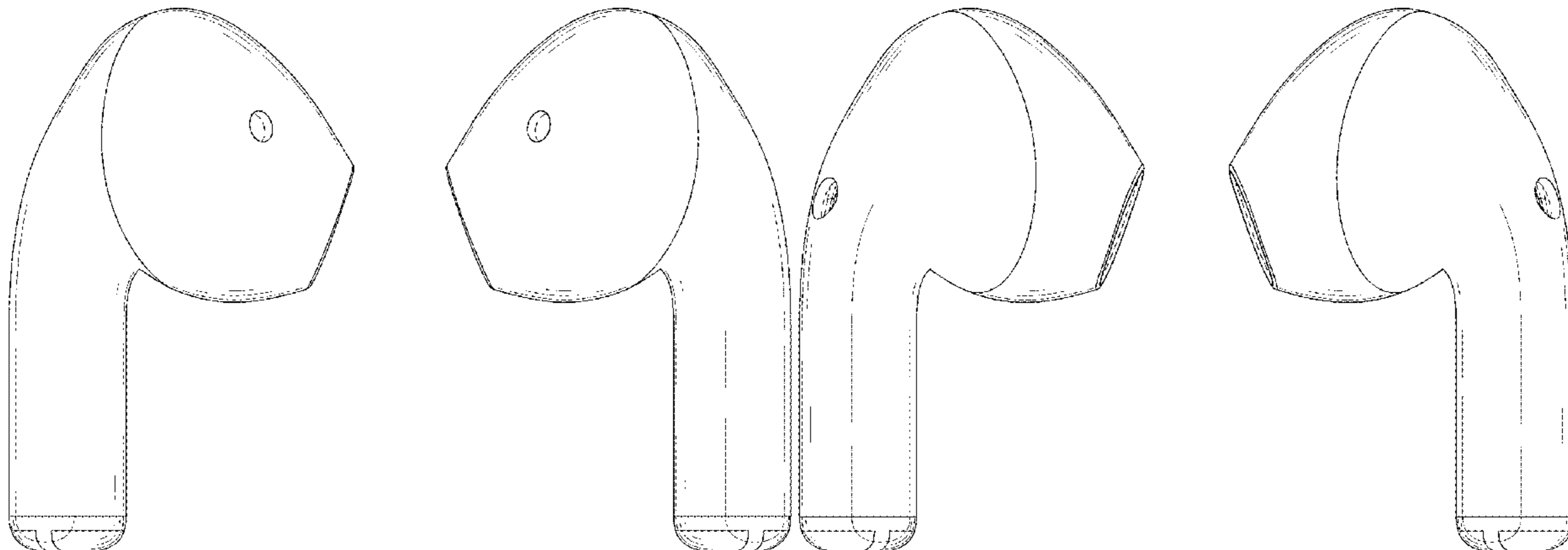
The ornamental design for wireless headset, as shown and described.

DESCRIPTION

FIG. 1 is a front elevational view of a wireless headset showing my new design;
FIG. 2 is a rear elevational view thereof;
FIG. 3 is a top plan view thereof.
FIG. 4 is a bottom plan view thereof;
FIG. 5 is a left side view thereof;
FIG. 6 is a right side view thereof; and,
FIG. 7 is a perspective view thereof.
The broken lines depicted portions of the wireless headset that form no part of the claimed design.

1 Claim, 7 Drawing Sheets

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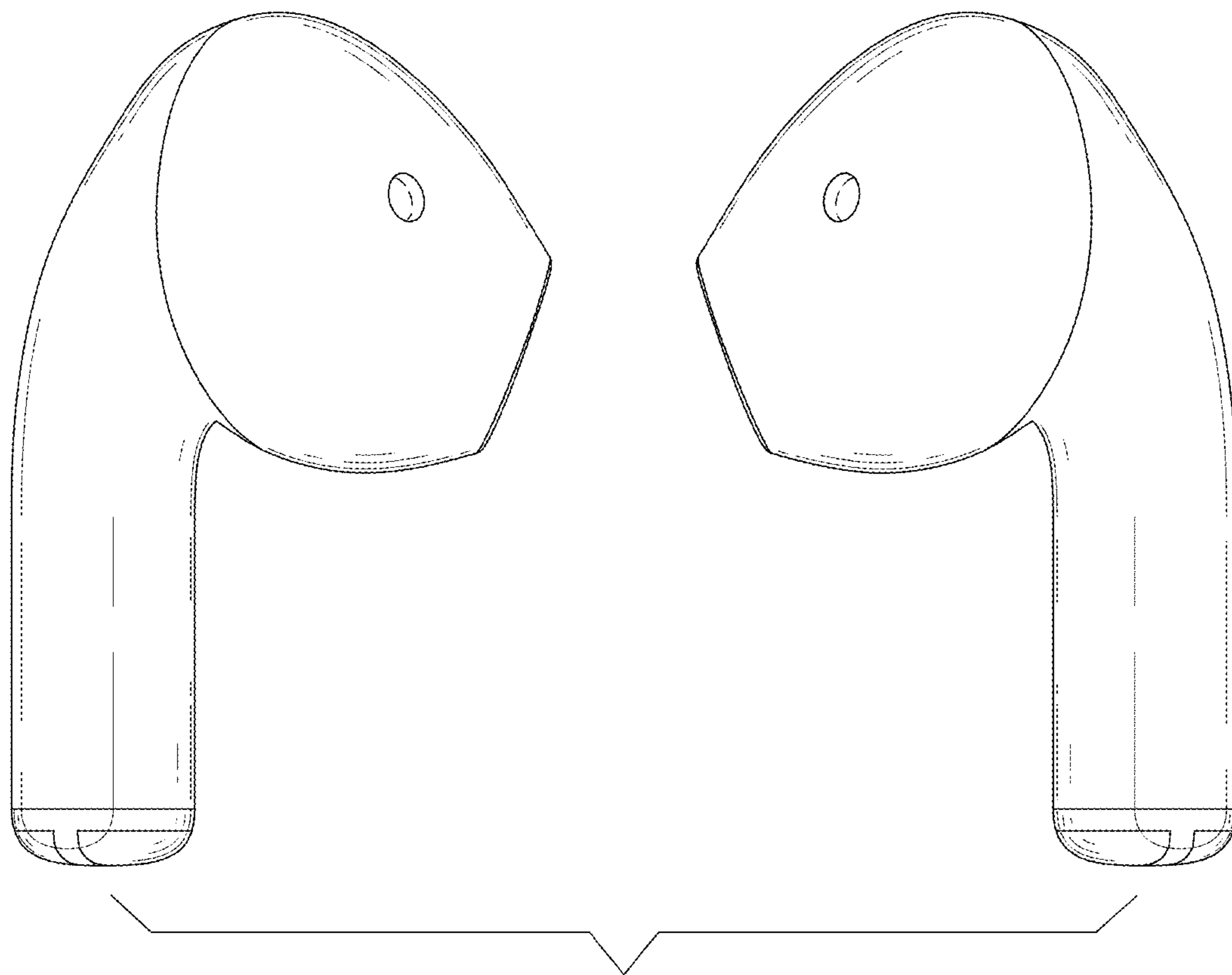


FIG. 1

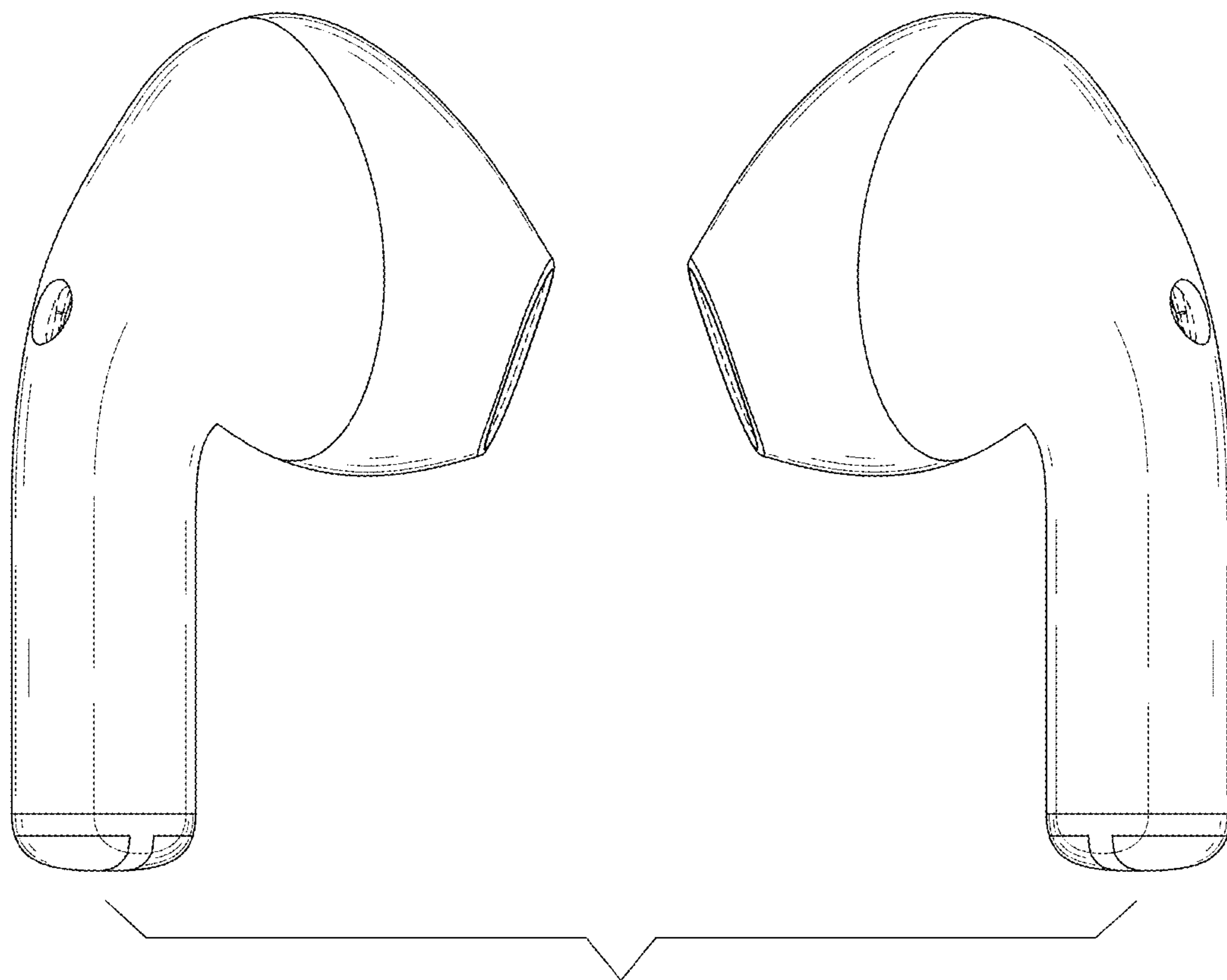


FIG. 2

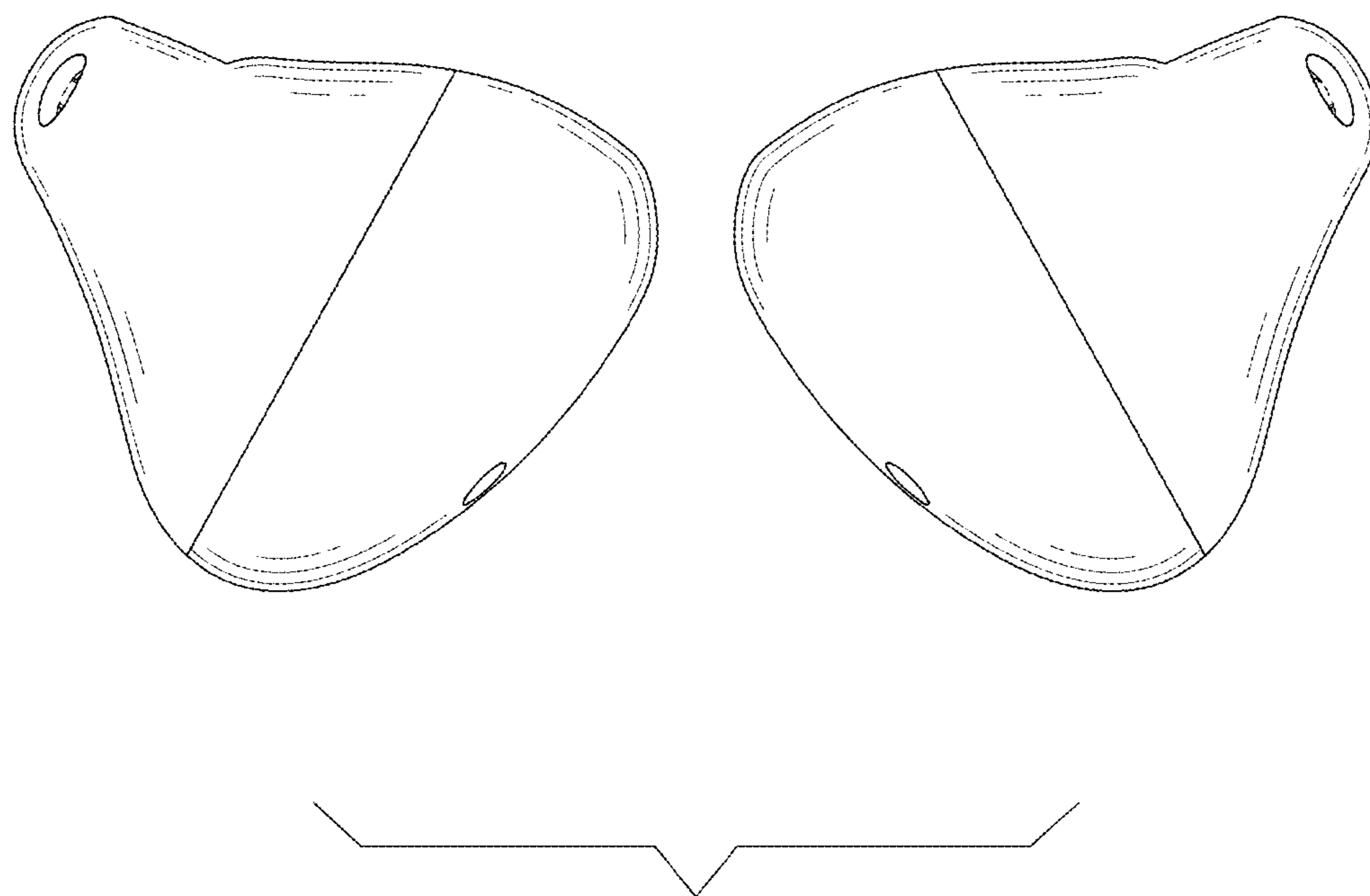


FIG. 3

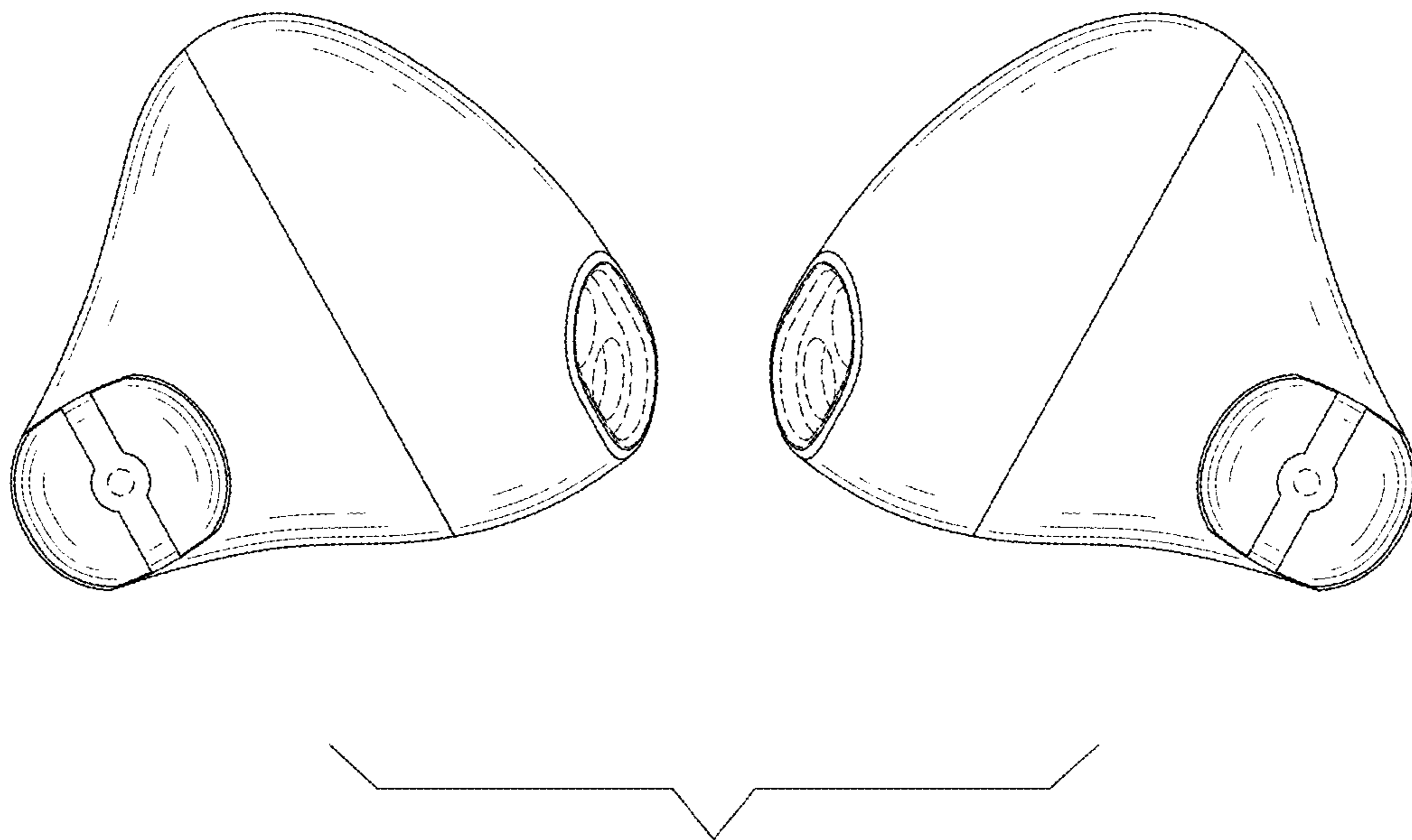


FIG. 4

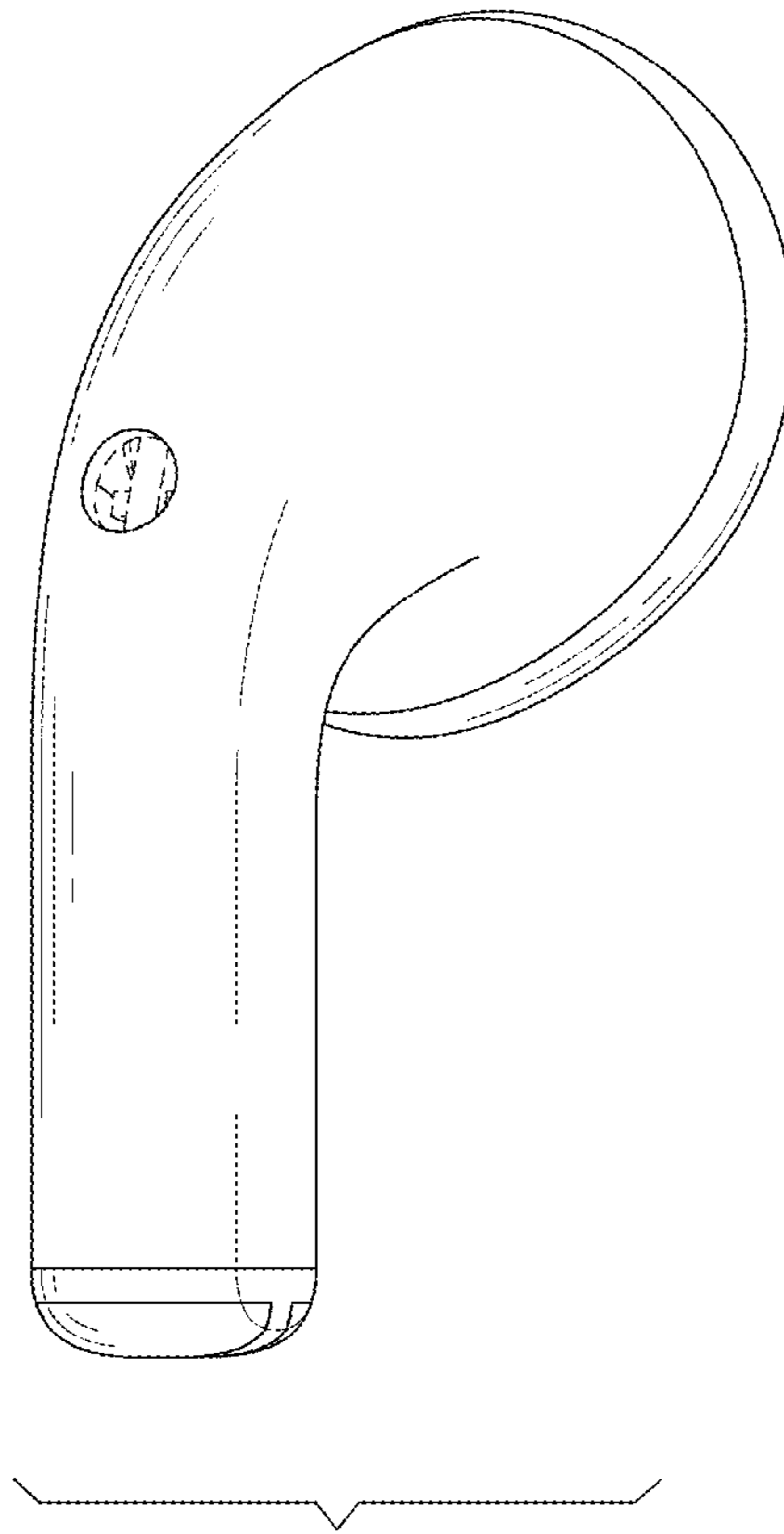


FIG. 5

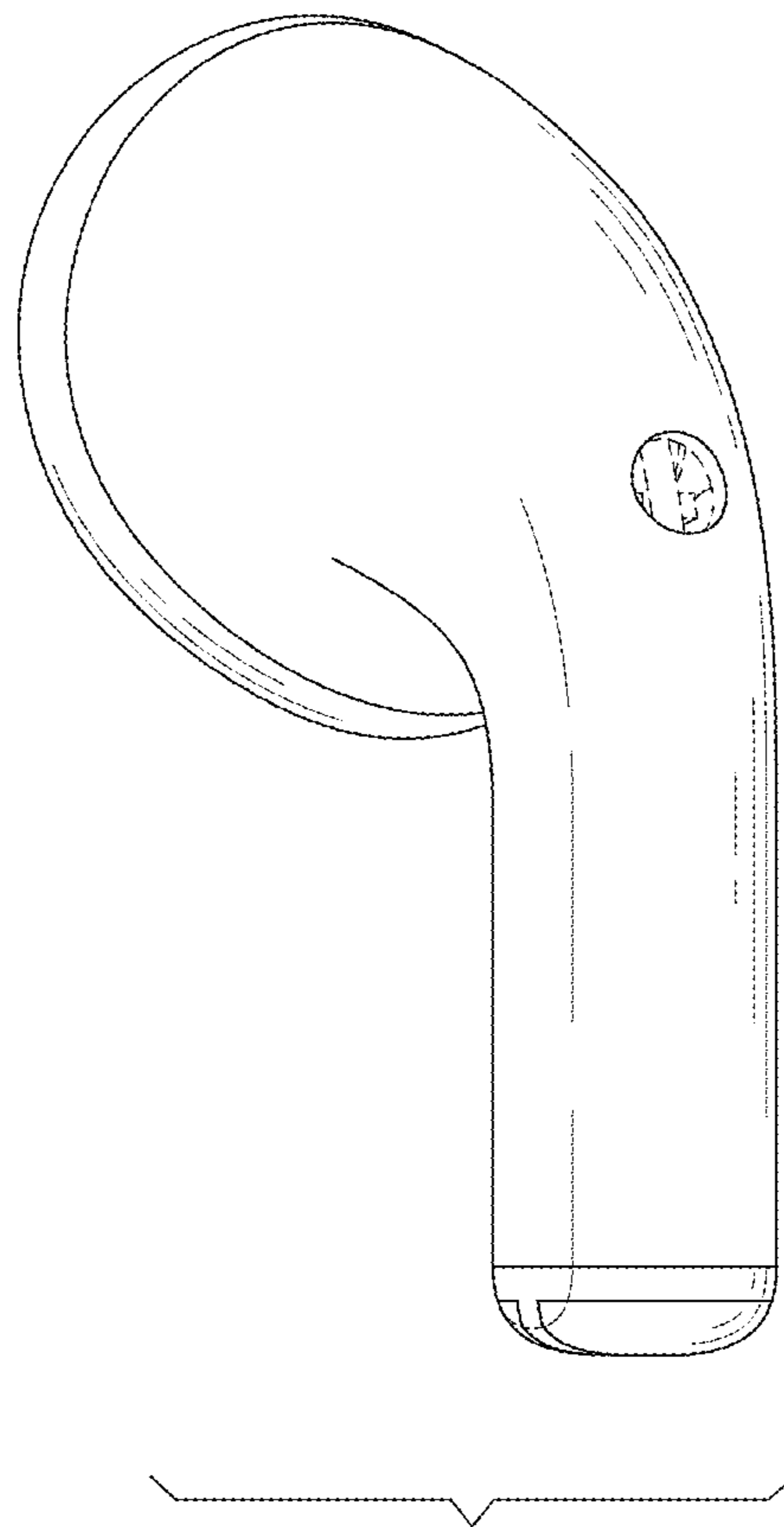


FIG. 6

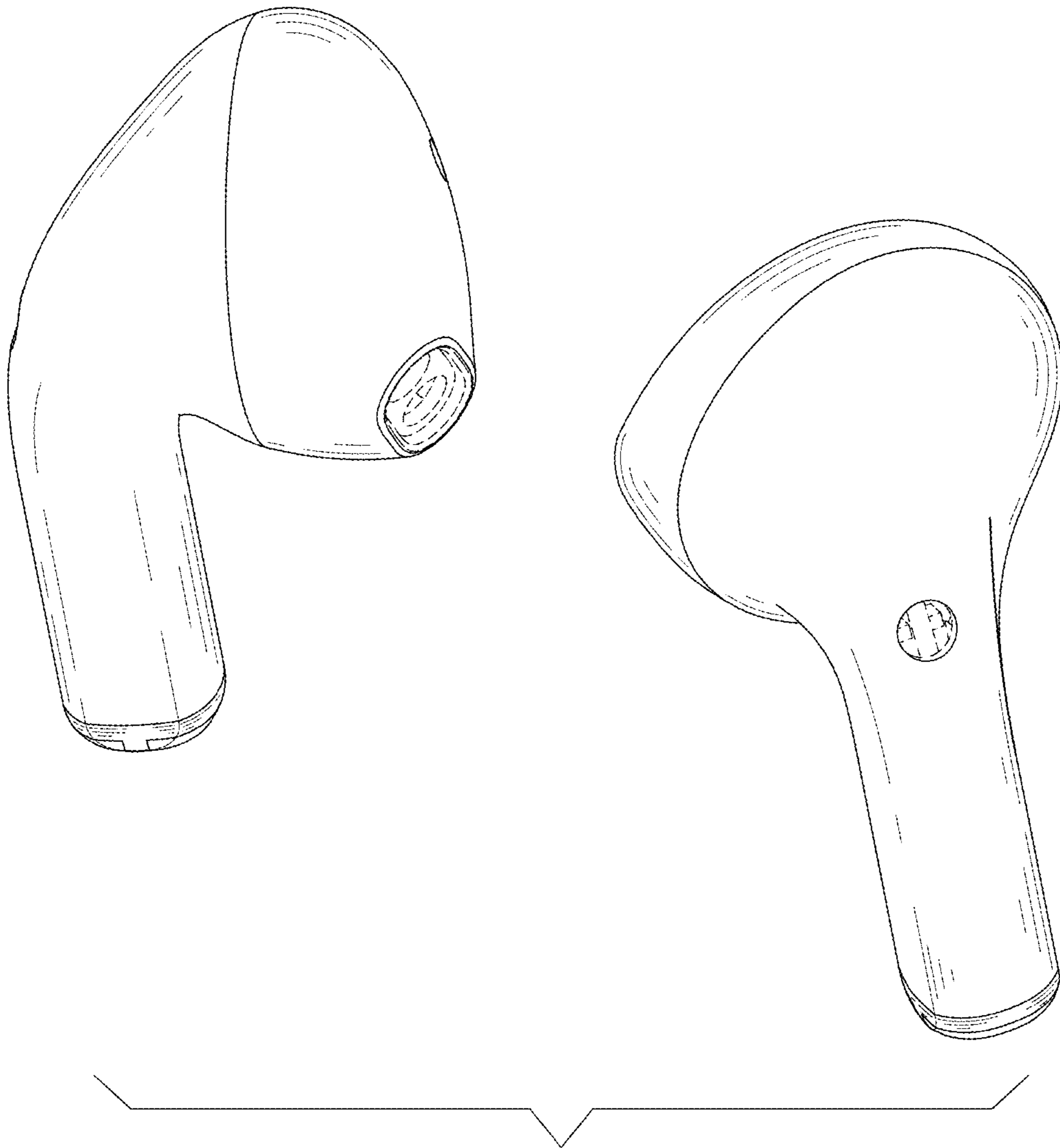


FIG. 7